



#### **60V P-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub>                           | I <sub>D</sub><br>T <sub>C</sub> = +25°C |
|-------------------|---|--|
| -60V              | $150 \text{m}\Omega$ @ $V_{GS} = -10V$        | -9.4A                                    |
| -00 V             | $185 \text{m}\Omega @ V_{GS} = -4.5 \text{V}$ | -8.5A                                    |

#### **Description**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

#### **Applications**

- Backlighting
- DC-DC Converters
- Power Management Functions

#### **Features**

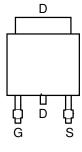
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-resistance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

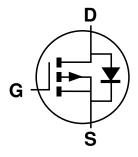
- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208e3
- Weight: 0.33 grams (Approximate)



Top View



Top View Pin-Out



**Equivalent Circuit** 

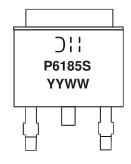
#### **Ordering Information** (Note 4)

| Product       | Case         | Packaging         |
|---------------|--------------|-------------------|
| DMP6185SK3-13 | TO252 (DPAK) | 2,500/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



O':| = Manufacturer's Marking P6185S = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 16 = 2016) WW = Week (01 to 53)



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

| Characteristic   | Symbol           | Value  | Units          |              |    |
|--|------------------|--|----------------|--------------|----|
| Drain-Source Voltage                                     | V <sub>DSS</sub> | -60  | V              |              |    |
| Gate-Source Voltage                                      | V <sub>GSS</sub> | ±20  | V              |              |    |
| Continuous Drain Current (Note C) V 10V                  | Steady<br>State  | $T_A = +25^{\circ}C$<br>$T_A = +70^{\circ}C$     | I <sub>D</sub> | -3.6<br>-2.8 | А  |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V | Steady<br>State  | T <sub>C</sub> = +25°C<br>T <sub>C</sub> = +70°C | ID             | -9.4<br>-7.5 | А  |
| Maximum Body Diode Continuous Current                    | I <sub>S</sub>   | -2   | Α              |              |    |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%)       | I <sub>DM</sub>  | -15  | Α              |              |    |
| Avalanche Current (Note 7) L = 0.1mH                     | I <sub>AS</sub>  | -16  | A              |              |    |
| Avalanche Energy (Note 7) L = 0.1mH                      |                  |  | Eas            | 13           | mJ |

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                   | Symbol                            | Value           | Units |      |
|--|-----------------------------------|-----------------|-------|------|
| Total Power Dissipation (Note 5)                 | $T_A = +25$ °C                    | P <sub>D</sub>  | 1.6   | - w  |
| Total Fower Dissipation (Note 5)                 | $T_A = +70^{\circ}C$              | PD              | 1.0   |      |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady state                      | $R_{\theta,JA}$ | 75    | °C/W |
| Thermal nesistance, bunction to Ambient (Note 3) | t<10s                             | пөја            | 38    |      |
| Total Power Dissipation (Note 6)                 |                                   | Б               | 2.8   | w    |
| Total Fower Dissipation (Note o)                 | $T_A = +70^{\circ}C$              | $P_{D}$         | 1.8   | ] vv |
| Thermal Resistance, Junction to Ambient (Note 6) |                                   | D               | 44    |      |
| Thermal nesistance, bunction to Ambient (Note o) | t<10s                             | Reja            | 20    | °C/W |
| Thermal Resistance, Junction to Case (Note 6)    | $R_{	heta JC}$                    | 6.2             |       |      |
| Operating and Storage Temperature Range          | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150     | °C    |      |

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                              | Symbol              | Min  | Тур   | Max  | Unit  | Test Condition   |  |
|---|---------------------|------|-------|------|-------|--|--|
| OFF CHARACTERISTICS (Note 8)                |                     |      |       |      |       |  |  |
| Drain-Source Breakdown Voltage              | BV <sub>DSS</sub>   | -60  | 1     |      | V     | $V_{GS} = 0V, I_D = -250\mu A$                                     |  |
| Zero Gate Voltage Drain Current             | I <sub>DSS</sub>    |      |       | -1   | μΑ    | $V_{DS} = -48V, V_{GS} = 0V$                                       |  |
| Gate-Source Leakage                         | I <sub>GSS</sub>    | _    | _     | ±100 | nA    | $V_{GS} = \pm 20V, V_{DS} = 0V$                                    |  |
| ON CHARACTERISTICS (Note 8)                 |                     |      |       |      |       |  |  |
| Gate Threshold Voltage                      | $V_{GS(TH)}$        | -1.0 | I     | -3.0 | ٧     | $V_{DS} = V_{GS}, I_D = -250 \mu A$                                |  |
| Static Drain-Source On-Resistance           |                     |      | 120   | 150  | mΩ    | $V_{GS} = -10V, I_D = -12A$  |  |
| Static Diani-Source On-Nesistance           | R <sub>DS(ON)</sub> |      | 150   | 185  | 11122 | $V_{GS} = -4.5V, I_D = -8A$  |  |
| Diode Forward Voltage                       | $V_{SD}$            |      | -0.75 | -1.2 | ٧     | $V_{GS} = 0V, I_{S} = -1A$   |  |
| DYNAMIC CHARACTERISTICS (Note 9)            |                     |      |       |      |       |  |  |
| Input Capacitance                           | C <sub>iss</sub>    | -    | 708   | _    | рF    | V 00V V 0V   |  |
| Output Capacitance                          | Coss                | _    | 39    | _    | pF    | $V_{DS} = -30V, V_{GS} = 0V,$<br>- f = 1.0MHz                      |  |
| Reverse Transfer Capacitance                | Crss                | -    | 32    | _    | рF    | 1 – 1.0101112  |  |
| Gate Resistance                             | $R_{g}$             |      | 17    | 40   | Ω     | $V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$                         |  |
| Total Gate Charge (V <sub>GS</sub> = -4.5V) | $Q_g$               | -    | 6.2   | _    | nC    |  |  |
| Total Gate Charge (V <sub>GS</sub> = -10V)  | $Q_{g}$             |      | 14    | _    | nC    | V 20V I 12A  |  |
| Gate-Source Charge                          | $Q_{gs}$            |      | 2.8   | _    | nC    | $V_{DS} = -30V, I_{D} = -12A$                                      |  |
| Gate-Drain Charge                           | $Q_{gd}$            | _    | 3.1   | _    | nC    |  |  |
| Turn-On Delay Time                          | t <sub>D(ON)</sub>  |      | 5.2   | _    | ns    |  |  |
| Turn-On Rise Time                           | t <sub>R</sub>      |      | 23    | _    | ns    | $V_{DS} = -30V, R_L = 2.5\Omega$<br>$V_{GS} = -10V, R_G = 3\Omega$ |  |
| Turn-Off Delay Time                         | t <sub>D(OFF)</sub> | _    | 33    | _    | ns    |  |  |
| Turn-Off Fall Time                          | t <sub>F</sub>      |      | 39    | _    | ns    |  |  |
| Body Diode Reverse Recovery Time            | t <sub>RR</sub>     | _    | 22    | _    | ns    | 1 100 di/dt 1000/u-  |  |
| Body Diode Reverse Recovery Charge          | Q <sub>RR</sub>     |      | 17    | _    | nC    | $I_F = -12A$ , di/dt = 100A/ $\mu$ s                               |  |

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. Notes:

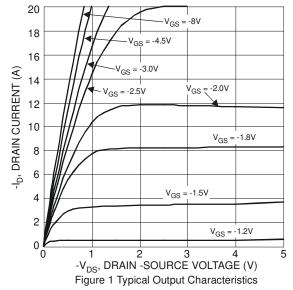
<sup>6.</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

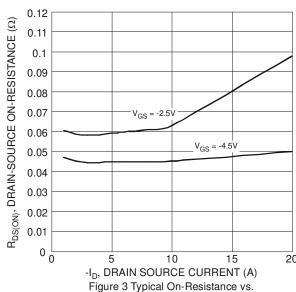
<sup>7.</sup>  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_{J} = +25^{\circ}C$ .

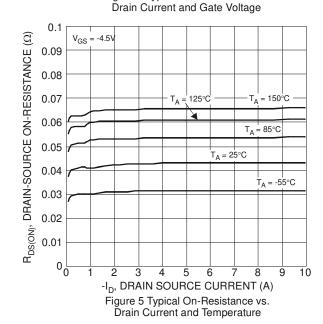
<sup>8.</sup> Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing.

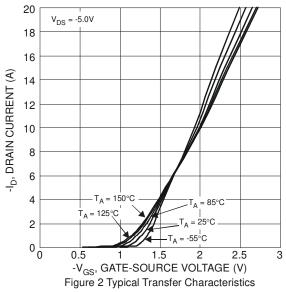


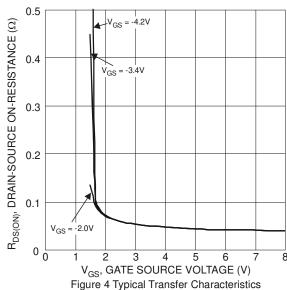


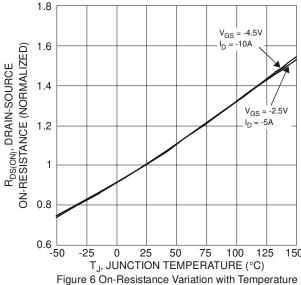




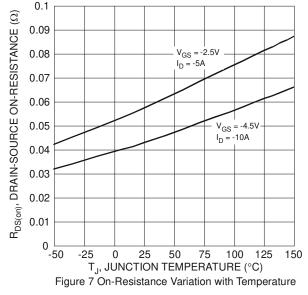


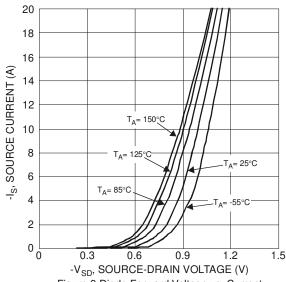


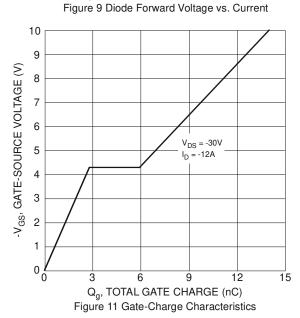


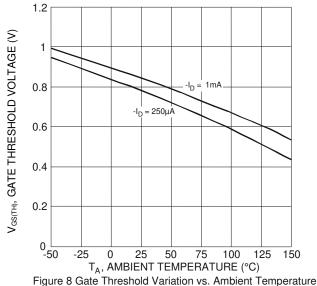


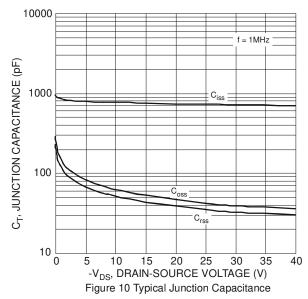












100 R<sub>DS(ON)</sub> 10 -ID, DRAIN CURRENT (A)  $P_W = 10ms$ 0.1 T<sub>J(max)</sub> = 150°C

T<sub>A</sub> = 25°C

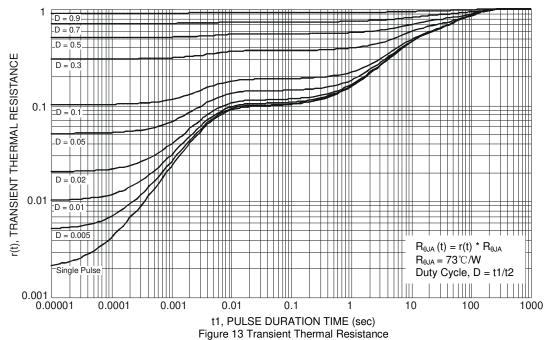
V<sub>GS</sub> = -10V

Single Pulse

DUT on 1 \* MRP Board 0.01 0.1 10 100  $\hbox{-V}_{DS},\, \hbox{DRAIN-SOURCE VOLTAGE}\,\, (\hbox{V})$ 

Figure 12 SOA, Safe Operation Area



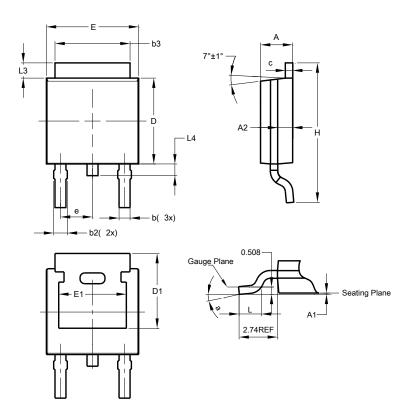




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TO252 (DPAK)

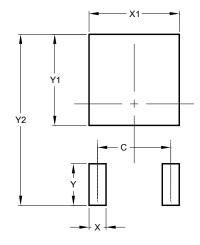


| TO252 (DPAK)         |      |       |       |  |  |
|----------------------|------|-------|-------|--|--|
| Dim                  | Min  | Max   | Тур   |  |  |
| Α                    | 2.19 | 2.39  | 2.29  |  |  |
| A1                   | 0.00 | 0.13  | 0.08  |  |  |
| A2                   | 0.97 | 1.17  | 1.07  |  |  |
| b                    | 0.64 | 0.88  | 0.783 |  |  |
| b2                   | 0.76 | 1.14  | 0.95  |  |  |
| b3                   | 5.21 | 5.46  | 5.33  |  |  |
| С                    | 0.45 | 0.58  | 0.531 |  |  |
| D                    | 6.00 | 6.20  | 6.10  |  |  |
| D1                   | 5.21 |       |       |  |  |
| е                    | -    | -     | 2.286 |  |  |
| Е                    | 6.45 | 6.70  | 6.58  |  |  |
| E1                   | 4.32 | -     | -     |  |  |
| Η                    | 9.40 | 10.41 | 9.91  |  |  |
| L                    | 1.40 | 1.78  | 1.59  |  |  |
| L3                   | 0.88 | 1.27  | 1.08  |  |  |
| L4                   | 0.64 | 1.02  | 0.83  |  |  |
| а                    | 0°   | 10°   | -     |  |  |
| All Dimensions in mm |      |       |       |  |  |

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TO252 (DPAK)



| Dimensions | Value (in mm) |  |  |
|------------|---------------|--|--|
| С          | 4.572         |  |  |
| Х          | 1.060         |  |  |
| X1         | 5.632         |  |  |
| Υ          | 2.600         |  |  |
| Y1         | 5.700         |  |  |
| Y2         | 10.700        |  |  |



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